

12 A Three-quadrant triacs, insulated, high commutation, high temperature

Rev. 01 — 3 October 2007

Product data sheet

1. Product profile

1.1 General description

Passivated, new generation, high commutation triacs in an internally insulated TO-220 plastic package

1.2 Features

- Very high commutation performance
- Isolated mounting base
- High operating junction temperature

1.3 Applications

- Heating and cooking appliances
- High power motor control e.g. vacuum cleaners
- Solid state relays

1.4 Quick reference data

- V_{DRM} ≤ 600 V (BTA412Y-600B/C)
- V_{DRM} ≤ 800 V (BTA412Y-800B/C)
- I_{T(RMS)} ≤ 12 A

- High immunity to dV/dt
- 2500 V RMS isolation voltage
- Non-linear rectifier-fed motor loads
- Electronic thermostats for heating and cooling loads
- I_{GT} ≤ 50 mA (BTA412Y series B)
- I_{GT} \leq 35 mA (BTA412Y series C)
- I_{TSM} ≤ 140 A (t = 20 ms)



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SOT78D (TO-220)

2. Pinning information

Table 1.	Pinning		
Pin	Description	Simplified outline	Symbol
1	main terminal 1 (T1)		ν.
2	main terminal 2 (T2)	mb	T2-T1
3	gate (G)	r 🔾 h	Sym051
mb	mounting base; isolated		

3. Ordering information

Table 2.Ordering information

Type number	Package					
	Name	Description	Version			
BTA412Y-600B		plastic single-ended package; isolated heatsink mounted; 1 mounting hole;	SOT78D			
BTA412Y-600C		3-lead TO-220				
BTA412Y-800B						
BTA412Y-800C						

4. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

	•				
Symbol	Parameter	Conditions	Min	Max	Unit
V _{DRM}	repetitive peak off-state voltage	BTA412Y-600B; BTA412Y-600C	<u>[1]</u> _	600	V
		BTA412Y-800B; BTA412Y-800C	-	800	V
I _{T(RMS)}	RMS on-state current	full sine wave; $T_{mb} \le 116 \text{ °C}$; see Figure 4 and 5	-	12	А
I _{TSM}	non-repetitive peak on-state current	full sine wave; $T_j = 25 \text{ °C prior to}$ surge; see <u>Figure 2</u> and <u>3</u>			
		t = 20 ms	-	140	А
		t = 16.7 ms	-	153	А
l ² t	l ² t for fusing	t = 10 ms	-	98	A ² s
dl _T /dt	rate of rise of on-state current	$I_{TM} = 20 \text{ A}; I_G = 0.2 \text{ A};$ $dI_G/dt = 0.2 \text{ A}/\mu \text{s}$	-	100	A/μs
I _{GM}	peak gate current		-	2	А
P _{GM}	peak gate power		-	5	W

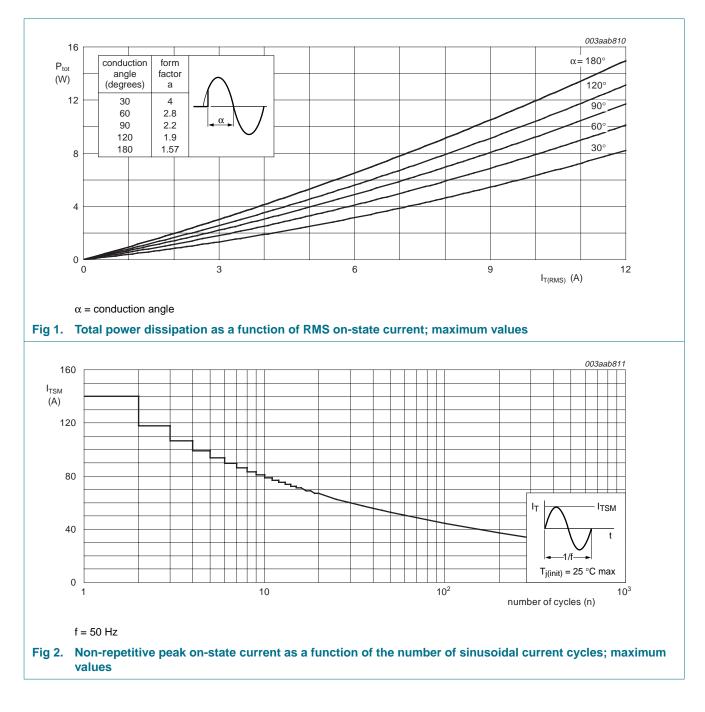
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Table 3.Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
P _{G(AV)}	average gate power	over any 20 ms period	-	0.5	W
T _{stg}	storage temperature		-40	+150	°C
Tj	junction temperature		-	150	°C

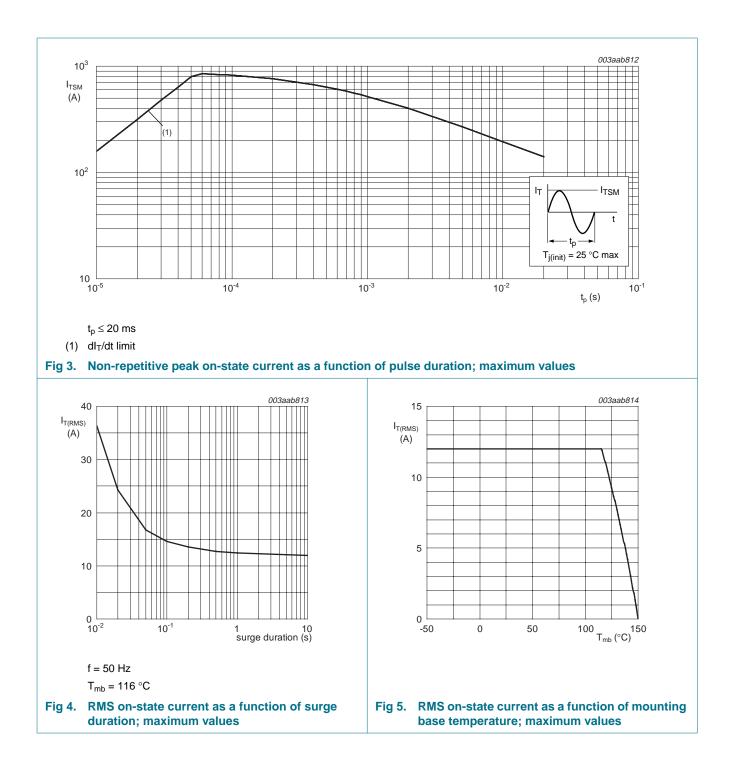
[1] Although not recommended, off-state voltages up to 800 V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 15 A/μs.



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BTA412Y series B and C

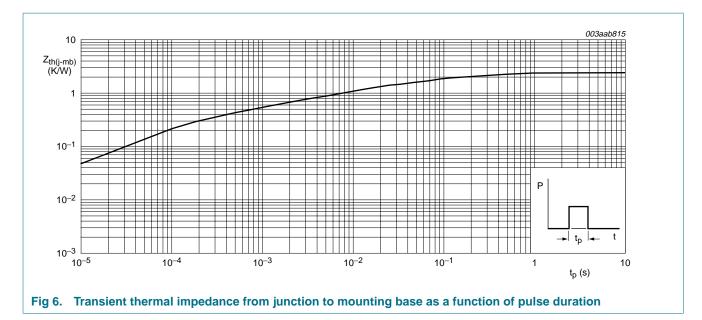
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Thermal characteristics 5.

Table 4.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	full cycle; see Figure 6	-	-	2.1	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	-	60	-	K/W



Isolation characteristics 6.

Isolation limiting values and characteristics Table 5.

 $T_h = 25 \circ C$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{isol(RMS)}	RMS isolation voltage	from all three terminals to external heatsink; f = 50 Hz to 60 Hz; sinusoidal waveform; RH \leq 65 %; clean and dust free	-	-	2500	V
C _{isol}	isolation capacitance	from pin 2 to external heatsink; f = 1 MHz	-	10	-	pF

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7. Static characteristics

Table 6. Static characteristics

 $T_i = 25 \circ C$ unless otherwise specified.

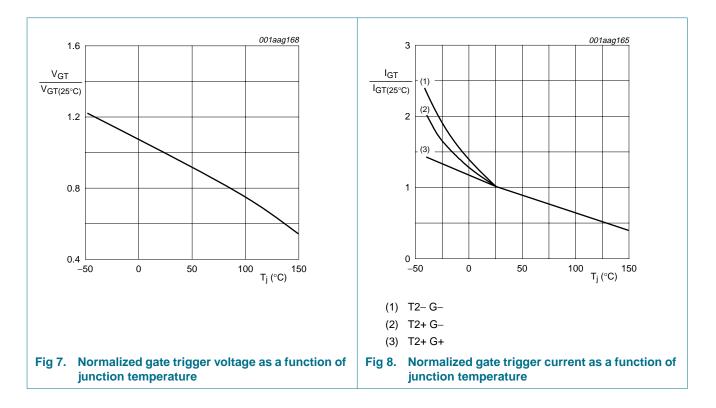
Symbol	Parameter	Conditions		BTA412Y-600B BTA412Y-800B			BTA412Y-600C BTA412Y-800C		
			Min	Тур	Max	Min	Тур	Max	
I _{GT}	gate trigger	$V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 8}}{100000000000000000000000000000000000$							
	current	T2+ G+	2	-	50	2	-	35	mA
		T2+ G-	2	-	50	2	-	35	mA
		T2-G-	2	-	50	2	-	35	mA
IL	latching current	$V_D = 12 \text{ V}; \text{ I}_{GT} = 0.1 \text{ A}; \text{ see } \frac{\text{Figure } 10}{100000000000000000000000000000000$							
		T2+ G+	-	-	60	-	-	50	mA
		T2+ G-	-	-	90	-	-	60	mA
		T2– G–	-	-	60	-	-	50	mA
I _H	holding current	$V_D = 12 \text{ V}; \text{ I}_{GT} = 0.1 \text{ A}; \text{ see } \frac{\text{Figure } 11}{\text{Figure } 11}$	-	-	60	-	-	35	mA
V _T	on-state voltage	$I_T = 18 \text{ A}; \text{ see } \overline{\text{Figure 9}}$	-	1.3	1.5	-	1.3	1.5	V
V _{GT}	gate trigger	$V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 7}}{100000000000000000000000000000000000$	-	0.8	1.5	-	0.8	1.5	V
	voltage	$V_D = 400 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T}_j = 150 \ ^\circ\text{C}$	0.25	0.4	-	0.25	0.4	-	V
I _D	off-state current	$V_D = V_{DRM(max)}; T_j = 125 \ ^{\circ}C$	-	0.1	0.5	-	0.1	0.5	mA
		$V_D = V_{DRM(max)}; T_j = 150 \ ^{\circ}C$	-	0.4	2	-	0.4	2	mA

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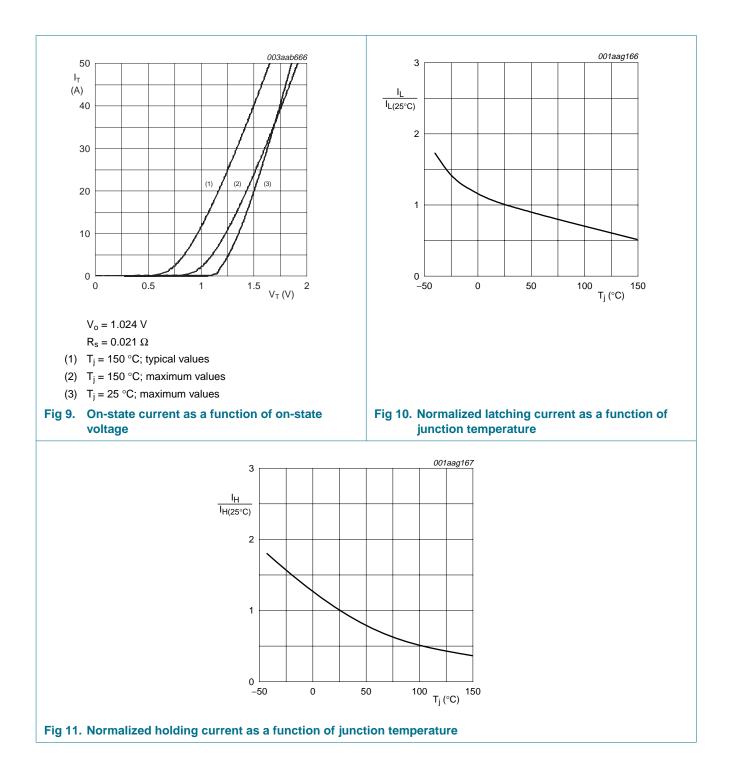
8. Dynamic characteristics

Table 7. Dynamic characteristics

Symbol	Parameter	Conditions	BTA412Y-600B BTA412Y-800B			BTA412Y-600C BTA412Y-800C			Unit
			Min	Тур	Max	Min	Тур	Max	
dV _D /dt rate of rise of off-state voltage	$V_{DM} = 0.67 \times V_{DRM(max)}$; T _j = 125 °C; exponential waveform; gate open circuit	1000	-	-	500	-	-	V/μs	
	voltage	$V_{DM} = 0.67 \times V_{DRM(max)}$; $T_j = 150 \text{ °C}$; exponential waveform; gate open circuit	600	-	-	300	-	-	V/µs
of comm	•••	V_{DM} = 400 V; T _j = 125 °C; I _{T(RMS)} = 12 A; without snubber; gate open circuit	20	-	-	15	-	-	A/ms
	commutating current	V_{DM} = 400 V; T _j = 150 °C; I _{T(RMS)} = 12 A; without snubber; gate open circuit	8	-	-	6	-	-	A/ms
t _{gt}	gate-controlled turn-on time	I_{TM} = 20 A; V_D = $V_{DRM(max)}$; I_G = 0.1 A; dI _G /dt = 5 A/µs	-	2	-	-	2	-	μs



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9. Package outline

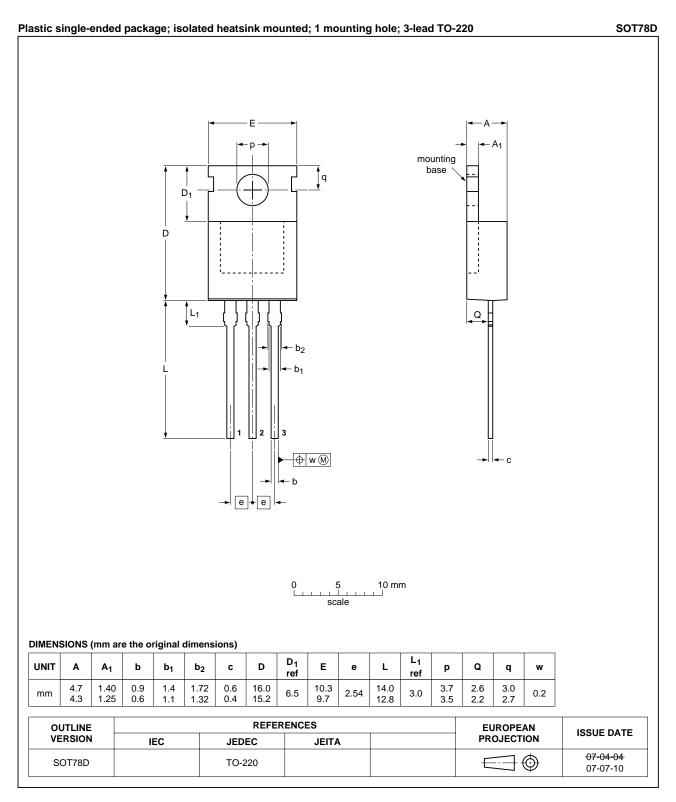


Fig 12. Package outline SOT78D (3-lead TO-220)

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10. Revision history

Table 8. Revision hist	Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
BTA412Y_SER_B_C_1	20071003	Product data sheet	-	-		

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11. Legal information

11.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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BTA412Y series B and C

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